Data Sheet



HLMP-3707, HLMP-3907, HLMP-3750, HLMP-3850, HLMP-3950, HLMP-3960, HLMP-3390, HLMP-3490, HLMP-3590, HLMP-1340, HLMP-1540, HLMP-K640

T-1¾ (5 mm), T-1 (3 mm), Ultra-Bright LED Lamps



Description

These Broadcom[®] non-diffused lamps out-perform conventional LED lamps. By using new higher intensity material, superior product performance is achieved.

Features

- Improved brightness
- Improved color performance
- Available in popular T-1 and T-1¾ packages
- New sturdy leads
- IC compatible/low current capability
- Reliable and rugged
- Choice of three bright colors
 - Red
 - Yellow
 - Green

Applications

- Lighted switches
- Backlighting front panels
- Light pipe sources
- Keyboard indicators

Package Dimensions

Figure 1: Package Outline "A" HLMP-3750/3850/3950

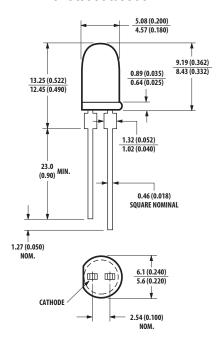


Figure 2: Package Outline "B" HLMP-3390/3490/3590

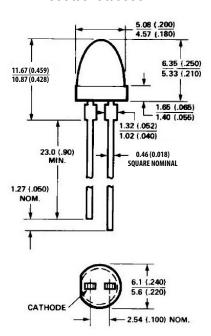
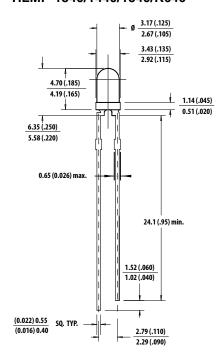


Figure 3: Package Outline "C" HLMP-1340/1440/1540/K640



NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. An epoxy meniscus may extend about 1 mm (0.04 in.) down the leads.
- 3. For PCB hole recommendations, see Precautions.

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Figure 4: Package Outline "D" **HLMP-3914**

5.08 (0.200) 4.57 (0.180) 9.19 (0.362) 8.43 (0.332) 0.65 MAX. (0.026) 0.89 (0.035) 0.64 (0.025) 25.40 (1.00) MIN. CATHODE LEAD (NOTE 1) 0.46 (0.018) SQUARE 1.27 (0.050) NOM. 5.59 (0.220)

Figure 5: Package Outline "E" **HLMP-3960**

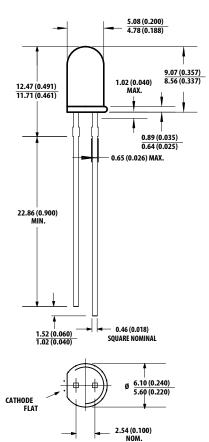
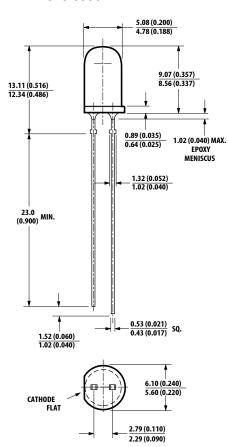


Figure 6: Package Outline "F" HLMP-3707/3907



NOTE:

1. All dimensions are in millimeters (inches).

2.54 (0.100) NOM.

- 2. An epoxy meniscus may extend about 1 mm (0.04 in.) down the leads.
- 3. For PCB hole recommendations, see Precautions.

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Device Selection Guide

			Luminous II	ntensity Iv (m	cd) at 20 mA	Viewing Angle 2θ _{1/2} (Degrees)	
Package Description	Color	Device HLMP-	Min.	Тур.	Max.		Package Outline
T-13/4	Red	3707-L00xx	90.2	_	_	24	F
		3750	90.2	125.0	_	24	Α
		3750-L00xx	90.2	125.0	_	24	Α
	Yellow	3850	96.2	140.0	_	24	Α
		3850-K00xx	96.2	140.0	_	24	Α
	Green	3914	111.7	_	_	24	D
		3950	111.7	265.0	_	24	Α
		3950-K00xx	111.7	265.0	_	24	Α
		3960-K0xxx	111.7	265.0	_	24	E
T-1¾ Low Profile	Red	3390	35.2	55.0	_	32	В
	Yellow	3490	37.6	55.0	_	32	В
	Green	3590	43.6	55.0	_	32	В
T-1	Red	1340	35.2	55.0	_	45	С
		1340-J00xx	35.2	55.0	_	45	С
	Yellow	1440	23.5	45.0	_	45	С
		1440-H00xx	23.5	45.0	_	45	С
	Green	1540	27.3	45.0	_	45	С
		1540-H00xx	27.3	45.0	_	45	С
		1540-IJ000	43.6	60.0	139.6	45	С
	Emerald Green	K640	4.2	21.0	_	45	С

Absolute Maximum Ratings at T_A = 25°C

Parameter	Red	Yellow	Green/Emerald Green	Units
Peak Forward Current	90	60	90	mA
Average Forward Current ^a	25	20	25	mA
DC Current ^b	30	20	30	mA
Reverse Voltage (I _R = 100 μA)	5	5	5	V
LED Junction Temperature	110	110	110	°C
Operating Temperature Range	-40 to +100	-40 to +100	-20 to +100	°C
Storage Temperature Range	-40 to +100	-40 to +100	-40 to +100	°C

a. See Figure 8 to establish pulsed operating conditions.

b. For Red and Green series, derate linearly from 50° C at 0.5 mA/°C. For Yellow series, derate linearly from 50° C at 0.2 mA/°C.

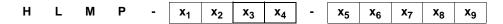
Electrical/Optical Characteristics at $T_A = 25$ °C

Parameter	Symbol	T-1¾	T-1¾ Low Dome	T-1	Min.	Тур.	Max.	Units	Test Conditions
Peak	λ _{PEAK}	37xx	3390	1340	_	632	_	nm	Measurement at
Wavelength		38xx	3490	1440	_	590	_		Peak
		39xx	3590	1540	_	570	_		
				K640	_	560	_		
Dominant	λ_{d}	37xx	3390	1340	_	626	_	nm	Note ^a
Wavelength		38xx	3490	1440	_	589	_		
		39xx	3590	1540	_	569	_		
				K640	_	559	_		
Spectral	$\Delta\lambda_{3/4}$	37xx	3390	1340	_	14	_	nm	
Line		38xx	3490	1440	_	12	_		
Halfwidth		39xx	3590	1540	_	13	_		
				K640	_	13	_		
Speed of	τ_{S}	37xx	3390	1340	_	90	_	ns	
Respond		38xx	3490	1440	_	90	_		
		39xx	3590	1540	_	500	_		
				K640	_	3100	_		
Capacitance	С	37xx	3390	1340	_	11	_	pF	V _F = 0, f = 1 MHz
		38xx	3490	1440	_	15	_		
		39xx	3590	1540	_	18	_		
				K640	_	35	_		
Thermal	Rθ _{J-PIN}	37xx	3390		_	210	_	°C/W	Junction to Cathode Lead
Resistance		38xx	3490		_	210	_		
		39xx	3590		_	210	_		
				1340	_	290	_		
				1440	_	290	_		
				1540	_	290	_		
				K640	_	290	_		
Forward	V_{F}	37xx	3390	1340	1.5	2.0	2.6	V	I _F = 20 mA
Voltage		38xx	3490	1440	1.5	2.0	2.6		
		39xx	3590	1540	1.5	2.1	3.0		
				K640	_	2.2	3.0		
Reverse	V_{R}	37xx	3390	1340	5.0	_	_	V	I _R = 100 μA
Breakdown	-	38xx	3490	1440					·
Voltage		39xx	3590	1540					
				K640					
Luminous	η_{v}	37xx	3390	1340	_	180	_	lumens/	Note ^b
Efficacy		38xx	3490	1440	_	500	_	watt	
		39xx	3590	1540	_	640	_		
				K640	_	660	_	1	

a. The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

b. The radiant intensity, le, in watts per steradian, may be found from the equation le = I_V / η_V , where I_V is the luminous intensity in candelas and η_V is the luminous efficacy in lumens/watt.

Part Numbering System



Code	Description	Option		
x ₁	Package Type	1	T-1 (3 mm)	
		K	T-1 (3 mm)	
		3	T-1¾ (5 mm)	
x ₂	Color	3, 7	Red	
		4, 8	Yellow	
		5, 9	Green	
			Emerald Green	
x ₃ x ₄	Product Specific Designation	_		
x ₅	Minimum Intensity Bin	See Intensity Bin Limits		
x ₆	Maximum Intensity Bin	0	Open (no maximum limit)	
		Others	See Intensity Bin Limits	
x ₇	Color Bin Selection	0	Full range	
x ₈ x ₉	Packaging Option	00	Bulk packaging	
		01	Tape and reel, crimped leads	
		02	Tape and reel, straight leads	
		A1	Right angle housing, uneven leads	
		A2, B2	Right angle housing, even leads	

Intensity Bin Limits

		Intensity R	ange (mcd)	
Color	Bin	Min.	Max.	
Red	G	9.7	15.5	
	Н	15.5	24.8	
	I	24.8	39.6	
	J	39.6	63.4	
	K	63.4	101.5	
	L	101.5	162.4	
	M	162.4	234.6	
	N	234.6	340.0	
	0	340.0	540.0	
	Р	540.0	850.0	
	Q	850.0	1200.0	
	R	1200.0	1700.0	
	S	1700.0	2400.0	
	Т	2400.0	3400.0	
	U	3400.0	4900.0	
	V	4900.0	7100.0	
	W	7100.0	10200.0	
	X	10200.0	14800.0	
	Υ	14800.0	21400.0	
	Z	21400.0	30900.0	
Yellow	F	10.3	16.6	
	G	16.6	26.5	
	Н	26.5	42.3	
	I	42.3	67.7	
	J	67.7	108.2	
	K	108.2	173.2	
	L	173.2	250.0	
	М	250.0	360.0	
	N	360.0	510.0	
	0	510.0	800.0	
	Р	800.0	1250.0	
	Q	1250.0	1800.0	
	R	1800.0	2900.0	
	S	2900.0	4700.0	
	Т	4700.0	7200.0	
	U	7200.0	11700.0	
	V	11700.0	18000.0	
	W	18000.0	27000.0	

		Intensity R	ange (mcd)
Color	Bin	Min.	Max.
Green/	Α	1.1	1.8
Emerald Green	В	1.8	2.9
	С	2.9	4.7
	D	4.7	7.6
	Е	7.6	12.0
	F	12.0	19.1
	G	19.1	30.7
	Н	30.7	49.1
	I	49.1	78.5
	J	78.5	125.7
	K	125.7	201.1
	L	201.1	289.0
	М	289.0	417.0
	N	417.0	680.0
	0	680.0	1100.0
	Р	1100.0	1800.0
	Q	1800.0	2700.0
	R	2700.0	4300.0
	S	4300.0	6800.0
	Т	6800.0	10800.0
	U	10800.0	16000.0
	V	16000.0	25000.0
	W	25000.0	40000.0

Maximum tolerance for each bin limit is \pm 18%.

Color Categories

		Lambda (nm)		
Color	Cat #	Min.	Max.	
Emerald Green	9	552.5	555.5	
	8	555.5	558.5	
	7	558.5	561.5	
	6	561.5	564.5	
Green	6	561.5	564.5	
	5	564.5	567.5	
	4	567.5	570.5	
	3	570.5	573.5	
	2	573.5	576.5	
Yellow	1	582.0	584.5	
	3	584.5	587.0	
	2	587.0	589.5	
	4	589.5	592.0	
	5	592.0	593.0	

		Lambda (nm)		
Color	Cat #	Min.	Max.	
Orange	1	597.0	599.5	
	2	599.5	602.0	
	3	602.0	604.5	
	4	604.5	607.5	
	5	607.5	610.5	
	6	610.5	613.5	
	7	613.5	616.5	
	8	616.5	619.5	

Tolerance for each bin limit is ± 0.5 nm.

Packaging Option Matrix

Packaging Option Code	Definition
00	Bulk Packaging, minimum increment 500 pieces/bag
01	Tape and Reel, crimped leads, min. increment 1300 pieces/reel for T-1¾, 1800 pieces/reel for T-1
02	Tape and Reel, straight leads, min. increment 1300 pieces/reel for T-1¾, 1800 pieces/reel for T-1
A1	T-1, Right Angle Housing, uneven leads, minimum increment 500 pieces/bag
A2	T-1, Right Angle Housing, even leads, minimum increment 500 pieces/bag
B2	T-1¾, Right Angle Housing, even leads, minimum increment 500 pieces/bag

NOTE: All categories are established for classification of products. Products may not be available in all categories. Contact your local Broadcom representative for further clarification and information.

Figure 7: Relative Intensity vs. Wavelength

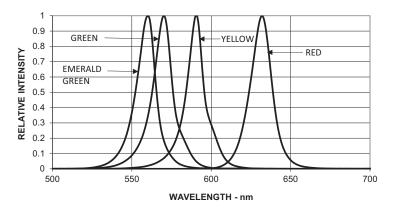


Figure 8: Maximum Tolerable Peak Current vs. Pulse Duration (I_{DC} MAX as per MAX Ratings)

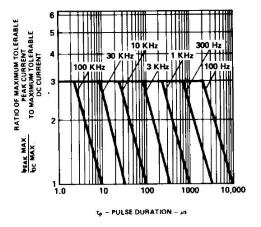


Figure 10: Relative Luminous Intensity vs. Forward Current

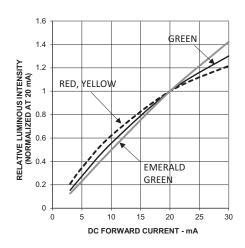


Figure 9: Forward Current vs. Forward Voltage

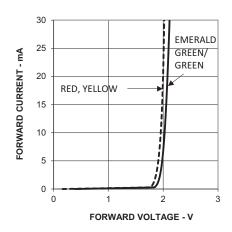


Figure 11: Relative Luminous Intensity vs. Angular Displacement, T-1³/₄ Lamp

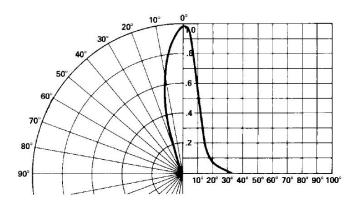


Figure 12: Relative Luminous Intensity vs. Angular Displacement, T-1³/₄ Low Profile Lamp

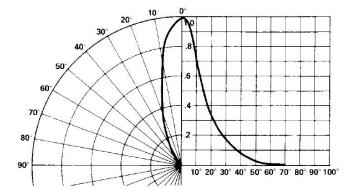
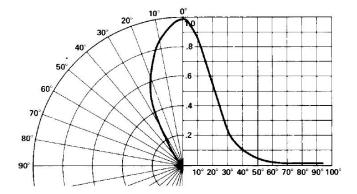


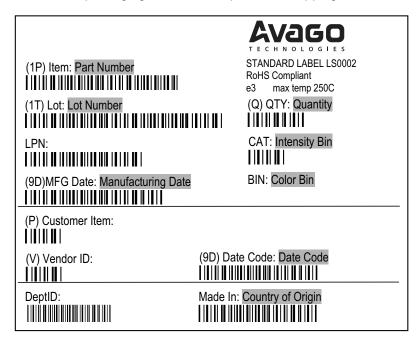
Figure 13: Relative Luminous Intensity vs. Angular Displacement, T-1 Lamp



Packaging Label

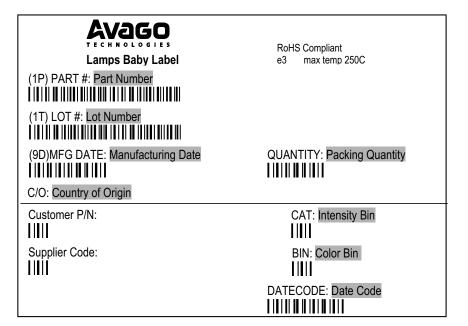
Mother Label

Available on packaging box of ammo pack and shipping box.



Baby Label

Only available on bulk packaging.



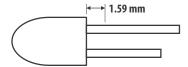
Precautions

Lead Forming

- Preform or cut the leads of an LED lamp to length prior to insertion and soldering on PC board.
- For better control, use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground that prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.

Soldering and Handling

- Take care during PCB assembly and soldering process to prevent damage to the LED component.
- The LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances, such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59 mm. Soldering the LED using soldering iron tip closer than 1.59 mm might damage the LED.



- Apply proper ESD precaution on the soldering station and by personnel to prevent ESD damage to the LED component that is ESD sensitive. For details, refer to Broadcom Application Note 1142. The soldering iron used should have a grounded tip to ensure electrostatic charge is properly grounded.
- Recommended soldering conditions follow.

	Wave Soldering ^a , ^b	Manual Solder Dipping
Pre-heat Temperature	105°C max.	_
Pre-heat Time	60s max.	_
Peak Temperature	250°C max.	260°C Max.
Dwell Time	3s max.	5s Max.

- These conditions refer to measurement with a thermocouple mounted at the bottom of PCB.
- To reduce thermal stress experienced by the LED, it is recommended that you use only the bottom preheaters.

 Set and maintain wave soldering parameters according to the recommended temperature and dwell time.
Perform daily checks on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

NOTE:

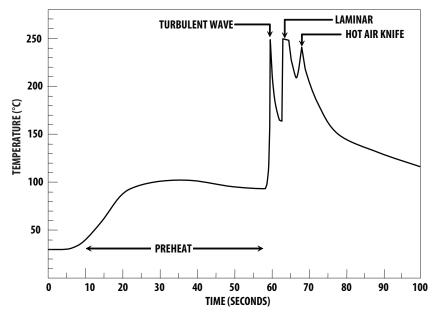
- PCBs with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, you should recalibrate the soldering profile again before loading a new type of PCB.
- Take extra precautions during wave soldering to ensure that the maximum wave temperature does not exceed 250°C and the solder contact time does not exceeding 3s. Over-stressing the LED during soldering process might cause premature failure to the LED due to delamination.
- Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on the LED. Nonmetal material is recommended as it will absorb less heat during wave soldering process.
- At elevated temperature, the LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, solder surface-mount components on the top side of the PCB. If surfacemount must be on the bottom side, solder these components using reflow soldering prior to insertion the TH LED.
- The following are the recommended PC board plated through holes (PTH) size for LED component leads.

	LED Component Lead Size	Diagonal	Plated Through- Hole Diameter
Lead size (typ.)	$0.45 \times 0.45 \text{ mm}$ (0.018 × 0.018 in.)		0.98 to 1.08 mm (0.039 to 0.043 in.)
Dambar shear- off area (max.)		0.919 mm (0.036 in.)	
Lead size (typ.)	$0.50 \times 0.50 \text{ mm}$ (0.020 × 0.020 in.)		1.05 to 1.15 mm (0.041 to 0.045 in.)
Dambar shear- off area (max.)		0.99 mm (0.039 in.)	

 Over-sizing the PTH can lead to a twisted LED after it is clinched. On the other hand, undersizing the PTH can make inserting the TH LED difficult.

For more information about soldering and handling of TH LED lamps, refer to Application Note 5334.

Example of Wave Soldering Temperature Profile for TH LED



Recommended solder: Sn63 (Leaded solder alloy) SAC305 (Lead free solder alloy)

Flux: Rosin flux

Solder bath temperature: $245^{\circ}C \pm 5^{\circ}C$ (maximum peak temperature = $250^{\circ}C$)

Dwell time: $1.5 \sec - 3.0 \sec (maximum = 3 \sec)$

Note: Allow for board to be sufficiently cooled to room temperature before exerting mechanical force. Recommended solder: Sn63 (Leaded solder alloy) SAC305 (Lead free solder alloy)

Flux: Rosin flux

Solder bath temperature: $245^{\circ}C \pm 5^{\circ}C$ (maximum peak temperature = $250^{\circ}C$)

Dwell time: $1.5 \sec - 3.0 \sec (maximum = 3 \sec)$

Note: Allow for board to be sufficiently cooled to room temperature before exerting mechanical force.

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